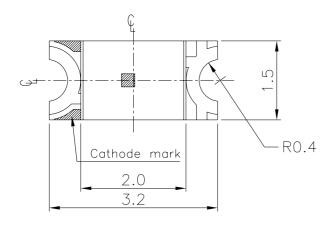
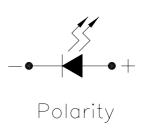
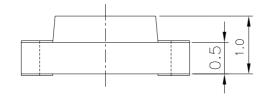


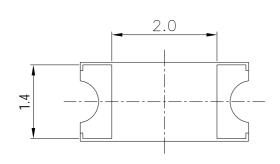
## **Package Outline Dimensions**

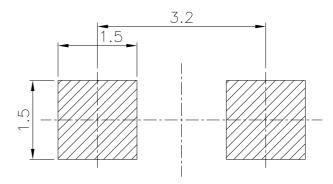






For reflow soldering (propose)





**Note:** Tolerances Unless Dimension is  $\pm 0.1$ mm, Unit = mm

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Device No: DSE-151-029

http://www.everlight.com

Rev 2

Page: 2 of 9

Prepared date: 6-Apr-2009

Prepared by: Huang yongxin



## **Absolute Maximum Ratings (Ta=25°C)**

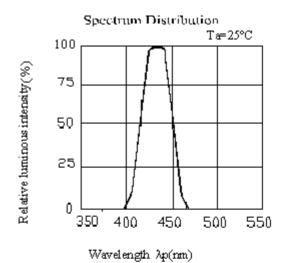
Parameter	Symbol	Rating	Unit		
Reverse Voltage	$V_R$	5	V		
Forward Current	$I_{\mathrm{F}}$	30	mA		
Peak Forward Current (Duty 1/10 @1KHz)	$I_{\mathrm{FP}}$	70	mA		
Power Dissipation	Pd	130	mW		
Electrostatic Discharge(HBM)	ESD	1000	V		
Operating Temperature	Topr	-40 ~ +85	$^{\circ}$		
Storage Temperature	Tstg	-40~ +90	$^{\circ}$		
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec.  Hand Soldering: 350 °C for 3 sec.			

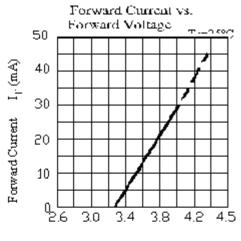
# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	14	18		mcd	
Viewing Angle	2 \theta 1/2		130		deg	
Peak Wavelength	λρ		428		nm	
Dominant Wavelength	λd		466		nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	Δλ		65		nm	
Forward Voltage	$V_{\mathrm{F}}$		3.8	4.5	V	
Reverse Current	$I_R$			50	$\mu$ A	V <sub>R</sub> =5V

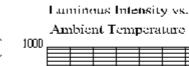
Everlight Electronics Co., Ltd. http://www.everlight.com Rev 2 Page: 3 of 9

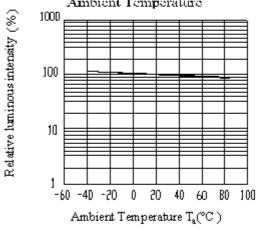
# **Typical Electro-Optical Characteristics**

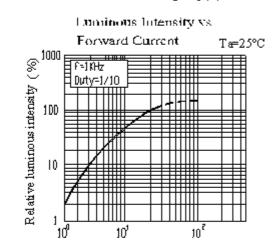




Forward Voltage  $V_F(V)$ 

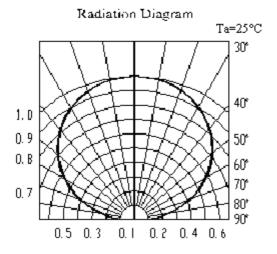






Forward Current Ip (mA)

#### Forward Current Denating Curve 50 Forward Current I<sub>F</sub> (m.A) 40 30 20 10 ٥٥٠ 40 60 100 85 Ambient Temperature Ta(°C)



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# Label explanation

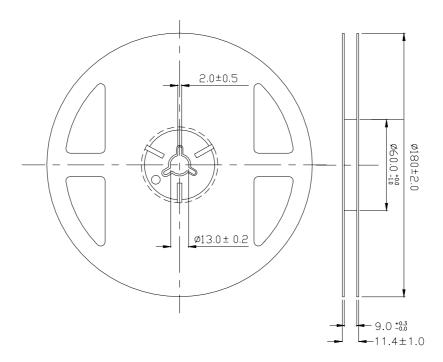
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**



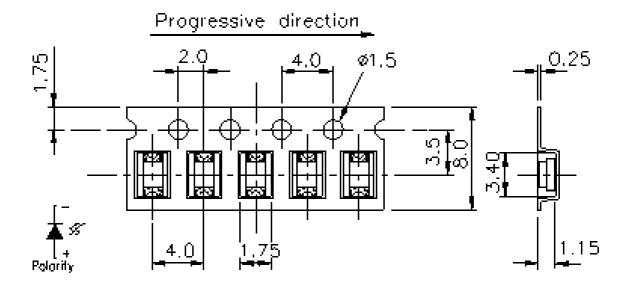
**Note:** Tolerances Unless Dimension is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 2 Page: 5 of 9



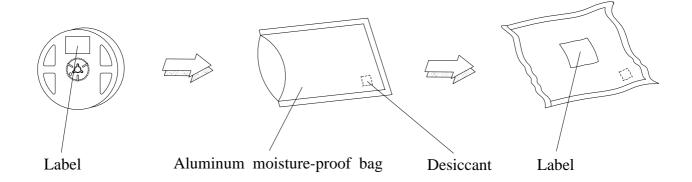
Page: 6 of 9

# Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



**Note:** Tolerances Unless Dimension is  $\pm 0.1$ mm, Unit = mm

## **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd. http://www.everlight.com Rev 2



# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°€	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 2 Page: 7 of 9

# EVERLIGHT ELECTRONICS CO.,LTD.

## 15-21UBC/C430/TR8

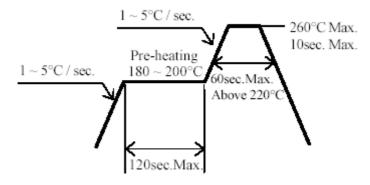
#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

    Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 2 Page: 8 of 9

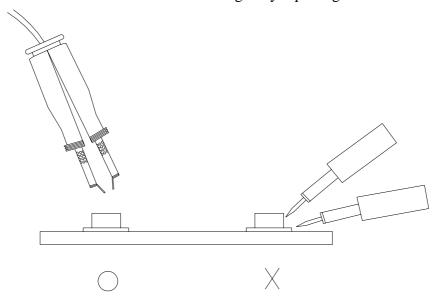


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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